

Docket No. 618902001410
(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Chun H. FAN et al.

Application No. 10/681,983

Confirmation No. 8846

Filed: October 9, 2003

Art Unit: 2826

For: MULTIPLE LEADFRAME LAMINATED IC
PACKAGE

Examiner: L. Andujar

STATEMENT OF SUBSTANCE OF INTERVIEW

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Applicants thank the Examiner for taking the time to confirm by telephone that the Advisory Action, mailed on November 15, 2007, is a duplicate of the Advisory Action, mailed November 7, 2007, and that the Request for Continued Examination filed November 13, 2007 has been entered along with the Amendment filed on October 15, 2007.

Dated: November 27, 2007

Respectfully submitted,

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